

## C0805Y223K3RACTU

**Specifications** 

Insulation Resistance

Aliases (C0805Y223K3RAC7800) SMD Comm X7R FF, Ceramic, 0.022 uF, 10%, 25 VDC, X7R, SMD, MLCC, FF-CAP, Floating Electrode, 0805, 0.7 mm



General Information	
Series	SMD Comm X7R FF
Style	SMD Chip
Description	SMD, MLCC, FF-CAP, Floating Electrode
Features	FF-CAP, Floating Electrode
RoHS	Yes
Termination	Flexible Termination
Marking	No
AEC-Q200	No
Typical Component Weight	13 mg
Shelf Life	78 Weeks
MSL	1

Dimensions	
Chip Size	0805
L	2mm +/-0.3mm
W	1.25mm +/-0.3mm
Т	0.78mm +/-0.20mm
S	0.7mm MIN
В	0.5mm +/-0.25mm

Capacitance	0.022 uF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	10%
Voltage DC	25 VDC
Dielectric Withstanding Voltage	62.5 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	X7R
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 1.0Vrms
Dissipation Factor	3.5% 1 kHz 1.0Vrms
Aging Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours

45.4545 GOhms

Packaging Specifications	
Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	4000

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